

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	EMBEDDED PROCESSING/26/15804	
1.3 Title of PCN	JSCC (China) additional source for STM32C011x listed products in UFQFPN 3X3 20L package	
1.4 Product Category	STM32C011F4Ux, STM32C011F6Ux.	
1.5 Issue date	2026-01-22	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Patrick AIDOUNE
2.1.2 Marketing Manager	Veronique BARLATIER
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Direct Material: Bond Wire - Metallurgy (metallic composition/ raw material)	StatsChipPAC JSCC Jiangyin (China)

4. Description of change

	Old	New
4.1 Description	Current assembly site: - Amkor ATP (Philippines) in Gold Wire	Current assembly site: - Amkor ATP (Philippines) in Gold Wire Additional assembly site for extended capacity: - JSCC (China) in copper palladium wire
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Form is changing as displayed in Additional Information document. No impact on Fit. No impact on Function.	

5. Reason / motivation for change

5.1 Motivation	To improve service
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	traceability ensured by ST internal tools
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7. Timing / schedule

7.1 Date of qualification results	2026-03-16
7.2 Intended start of delivery	2026-04-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	15804 MDRF-GPAM-RER2507 for PCN15804 JSCC (China) QFN4x4-3x3 New BOM - Reliab PLAN.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2026-01-22

9. Attachments (additional documentations)

15804 Public product.pdf
15804 MDRF-GPAM-RER2507 for PCN15804 JSCC (China) QFN4x4-3x3 New BOM - Reliab PLAN.pdf
15804 _Additional information.pdf

10. Affected parts

10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32C011F4U6TR	
	STM32C011F6U6TR	

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